

## 14-BIT REGISTERED BUFFER WITH SSTL I/O

#### FEATURES:

- 1:1 registered buffer
- Meets or exceeds JEDEC standards for SSTV16857 and SSTVN16857
- 2.3V to 2.7V operation for PC1600, PC2100, and PC2700
- 2.5V to 2.7V operation for PC3200
- · SSTL\_2 Class II style data inputs/outputs
- · Differential CLK input
- **RESET** control compatible with LVCMOS levels
- Flow-through architecture for optimum PCB design
- Drive up to equivalent of 18 SDRAM loads
- Latch-up performance exceeds 100mA
- ESD >2000V per MIL-STD-883, Method 3015; >200V using machine model (C = 200pF, R = 0)
- Available in TSSOP package

## **DESCRIPTION:**

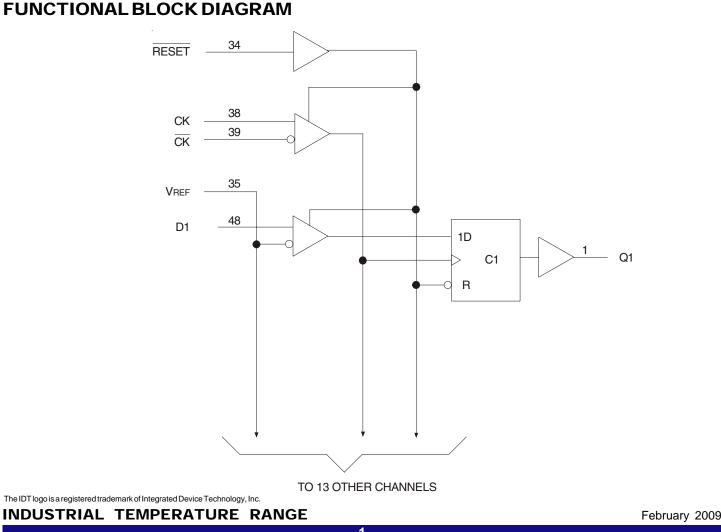
The SSTV16857 is a 14-bit registered buffer designed for 2.3V-2.7V VDD for PC1600-PC2700, and 2.5V-2.7V VDD for PC3200, and supports low standby operation. All data inputs and outputs are SSTL\_2 level compatible with JEDEC standard for SSTL\_2.

**RESET** is an LVCMOS input since it must operate predictably during the power-up phase. **RESET**, which can be operated independent of CLK and CLK, must be held in the low state during power-up in order to ensure predictable outputs (low state) before a stable clock has been applied.

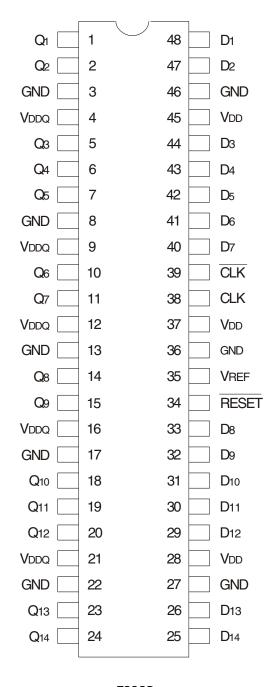
RESET, when in the low state, will disable all input receivers, reset all registers, and force all outputs to a low state, before a stable clock has been applied. With inputs held low and a stable clock applied, outputs will remain low during the Low-to-High transition of RESET.

#### **APPLICATIONS:**

 Along with CSPT857C/D, Zero Delay PLL Clock buffer, provides complete solution for DDR1 DIMMs



#### **PIN CONFIGURATION**



#### TSSOP TOP VIEW

#### **INDUSTRIAL TEMPERATURE RANGE**

### **ABSOLUTE MAXIMUM RATINGS**<sup>(1)</sup>

Symbol	Description	Max.	Unit
VDD or VDDQ	Supply Voltage Range	-0.5 to 3.6	V
VI <sup>(2)</sup>	Input Voltage Range	–0.5 to VDD +0.5	V
Vo <sup>(3)</sup>	Output Voltage Range	–0.5 to VDDQ +0.5	V
Iк Input Clamp Current, Vi < 0		-50	mA
Іок	Output Clamp Current,	±50	mA
	Vo < 0 or Vo > VDDQ		
lo	Continuous Output Current,	±50	mA
	Vo = 0 to VDDQ		
Vdd	Continuous Current through each	±100	mA
	VDD, VDDQ or GND		
Tstg	Storage Temperature Range	-65 to +150	°C

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. The input and output negative voltage ratings may be exceeded if the ratings of the I/P and O/P clamp current are observed.
- 3. The output current will flow if the following conditions are observed:

a) Output in HIGH state

b) Vo = VDDQ

#### **FUNCTION TABLE<sup>(1)</sup>**

RESET	CLK	CLK	D	Q Outputs
Н	$\uparrow$	$\downarrow$	L	L
Н	$\uparrow$	$\rightarrow$	Н	Н
Н	L or H	L or H	Х	Q <sup>(2)</sup>
L	Х	Х	Х	L

NOTES:

1. H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

 $\uparrow = LOW \text{ to HIGH}$  $\downarrow = HIGH \text{ to LOW}$ 

2. Q = Output level before the indicated steady-state conditions were established.

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE (PC1600-PC2700)

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, VDD =  $2.5V \pm 0.2V$ , VDDQ =  $2.5V \pm 0.2V$ 

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Vik	Control Inputs	Vdd = 2.3V, II = -18mA	-	—	-1.2	V
Vон		VDD = 2.3V to 2.7V, IOH = -100µA	Vdd - 0.2	_	_	V
		Vdd = 2.3V, Ioн = -16mA	1.95	—	—	
Vol		VDD = 2.3V to 2.7V, IOL = 100µA	—	—	0.2	V
		VDD = 2.3V, IOL = 16mA	-	—	0.35	
li	All Inputs	VDD = 2.7V, VI = VDD or GND	—	_	±5	μA
Idd	Static Standby	Io = 0, Vdd = 2.7V, <b>RESET</b> = GND	_	_	0.01	mA
	Static Operating	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = VDD, VI = VIH (AC) or VIL (AC)	-	—	_	
Iddd	Dynamic Operating (Clock Only)	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = VDD, VI = VIH (AC) or VIL (AC),	—	_	_	µA/Clock
		CLK and CLK Switching 50% Duty Cycle.				MHz
	Dynamic Operating	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = VDD, VI = VIH (AC) or VIL (AC),	-	—	_	µA/Clock
	(Per Each Data Input)	CLK and CLK Switching 50% Duty Cycle. One Data Input				MHz/Data
		Switching at Half Clock Frequency, 50% Duty Cycle.				Input
roh	Output HIGH	VDD = 2.3V to 2.7V, IOH = -20mA	7	—	20	Ω
rol	OutputLOW	VDD = 2.3V to 2.7V, IOH = 20mA	7	—	20	Ω
ΓΟ(Δ)	roн-rol each separate bit	Vdd = 2.5V, Ta = 25°C, Ioh = -20mA	—	—	4	Ω
	Data Inputs	Vdd = 2.5V, Vi = Vref ± 310mV	2.5	_	3.5	
Сі	CLK and CLK	VICR = 1.25V, VI (PP) = 360mV	2.5	_	3.5	pF
	RESET	VI = VDD or GND	_	_	_	

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE (PC3200)

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, VDD =  $2.6V \pm 0.1V$ , VDDQ =  $2.6V \pm 0.1V$ 

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Vik	Control Inputs	Vdd = 2.5V, II = -18mA	_	—	-1.2	V
Vон		Vdd = 2.5V to 2.7V, IOH = -100µА	Vdd - 0.2	—	_	V
		VDD = 2.5V, IOH = -16mA	1.95	_	_	
Vol		VDD = 2.5V to 2.7V, IOL = 100µA	—	_	0.2	V
		VDD = 2.5V, IOL = 16mA	-	_	0.35	
li	All Inputs	VDD = 2.7V, VI = VDD or GND	_	—	±5	μA
Idd	Static Standby	IO = 0, VDD = 2.7V, $\overline{\text{RESET}}$ = GND	_	_	0.01	mA
	Static Operating	IO = 0, VDD = 2.7V, RESET = VDD, VI = VIH (AC) or VIL (AC)	-	_	_	
IDDD	Dynamic Operating (Clock Only)	IO = 0, VDD = 2.7V, RESET = VDD, VI = VIH (AC) or VIL (AC),	_	—	_	µA/Clock
		CLK and CLK Switching 50% Duty Cycle.				MHz
	Dynamic Operating	IO = 0, VDD = 2.7V, RESET = VDD, VI = VIH (AC) or VIL (AC),	_	_	_	µA/Clock
	(Per Each Data Input)	CLK and CLK Switching 50% Duty Cycle. One Data Input				MHz/Data
		Switching at Half Clock Frequency, 50% Duty Cycle.				Input
roh	Output HIGH	VDD = 2.5V to 2.7V, IOH = -20mA	7	_	20	Ω
rol	Output LOW	Vdd = 2.5V to 2.7V, IOH = 20mA	7	—	20	Ω
ľΟ(Δ)	rон-rol each separate bit	Vdd = 2.6V, Ta = 25°С, Iон = -20mA	_	—	4	Ω
	Data Inputs	Vdd = 2.6V, Vi = Vref ± 310mV	2.5	_	3.5	
Сі	CLK and CLK	VICR = 1.3V, VI (PP) = 360mV	2.5	_	3.5	pF
	RESET	VI = VDD or GND	_	_	_	]

## OPERATING CHARACTERISTICS (PC1600-PC2700), TA = $25^{\circ}C^{(1)}$

Symbol	Parameter		Min.	Тур.	Max.	Unit
Vdd	SupplyVoltage		VDDQ	_	2.7	V
VDDQ	Output Supply Voltage		2.3	2.5	2.7	V
Vref	Reference Voltage (VREF= VDDQ/2)		1.15	1.25	1.35	V
Vtt	Termination Voltage		Vref-40mV	Vref	Vref+ 40mV	V
Vi	Input Voltage		0	_	Vdd	V
Vih	AC High-Level Input Voltage	Data Inputs	VREF+ 310mV	_	—	V
VIL	AC Low-Level Input Voltage	Data Inputs	-	— VREF-310mV		V
Vih	DC High-Level Input Voltage	Data Inputs	VREF+ 150mV	VREF+ 150mV —		V
VIL	DC Low-Level Input Voltage	Data Inputs	_	_	Vref-150mV	V
Vih	High-Level Input Voltage	RESET	1.7	_	—	V
VIL	Low-Level Input Voltage	RESET	-	_	0.7	V
VICR	Common-Mode Input Range	CLK, CLK	0.97	_	1.53	V
VI (PP)	Peak-to-Peak Input Voltage	CLK, CLK	360	360 — —		mV
Іон	High-Level Output Current			_	- 20	mA
Iol	Low-Level Output Current		-	—	20	
TA	Operating Free-Air Temperature		- 40	_	+85	°C

NOTE:

1. The RESET input of the device must be held at VDD or GND to ensure proper device operation.

## **OPERATING CHARACTERISTICS (PC3200)**, TA = 25°C<sup>(1)</sup>

Symbol	Parameter		Min.	Тур.	Max.	Unit
Vdd	SupplyVoltage		VDDQ	_	2.7	V
VDDQ	Output Supply Voltage		2.5	2.5	2.7	V
Vref	Reference Voltage (VREF=VDDQ/2)		1.25	1.3	1.35	V
Vtt	Termination Voltage		Vref-40mV	Vref	Vref+ 40mV	V
Vi	Input Voltage		0	_	Vdd	V
Vih	AC High-Level Input Voltage	Data Inputs	VREF+ 310mV			V
VIL	AC Low-Level Input Voltage	Data Inputs	—	_	VREF-310mV	
Vih	DC High-Level Input Voltage	Data Inputs	VREF+ 150mV	_	_	V
Vil	DC Low-Level Input Voltage	Data Inputs	_	_	Vref-150mV	V
Vih	High-Level Input Voltage	RESET	1.7	_	_	V
VIL	Low-Level Input Voltage	RESET	—	_	0.7	V
VICR	Common-Mode Input Range	CLK, CLK	0.97	_	1.53	V
VI (PP)	Peak-to-Peak Input Voltage	CLK, CLK	360	_	_	mV
Іон	High-Level Output Current			_	- 20	mA
Iol	Low-Level Output Current		_	—	20	
TA	Operating Free-Air Temperature		- 40	_	+85	°C

NOTE:

1. The  $\overline{\text{RESET}}$  input of the device must be held at VDD or GND to ensure proper device operation.

## TIMING REQUIREMENTS OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE

			PC1600-PC2700		PC3200		
Symbol	Parameter		Min.	Max.	Min.	Max.	Unit
CLOCK	Clock Frequency		_	200	_	220	MHz
tw	Pulse Duration, CLK, CLK HIGH or LOW		2.5	—	2.5	—	ns
<b>t</b> ACT	Differential Inputs Active Time <sup>(1)</sup>		—	22	—	22	ns
<b>t</b> INACT	Differential Inputs Inactive Time <sup>(2)</sup>		—	22	—	22	ns
tsu	Setup Time, Fast Slew Rate <sup>(3,5)</sup>	Data Before CLK↑, CLK↓	0.65	—	0.65	—	ns
	Setup Time, Slow Slew Rate <sup>(4, 5)</sup>		0.75	—	0.75	—	ns
ħ	Hold Time, Fast Slew Rate <sup>(3,5)</sup>	Data Before CLK $\uparrow$ , CLK $\downarrow$	0.75	—	0.75	—	ns
	Hold Time, Slow Slew Rate <sup>(2,5)</sup>		0.9	—	0.9	—	ns

NOTES:

1. Data inputs must be low a minimum time of tACT max., after RESET is taken HIGH.

2. Data and clock inputs must be held at valid levels (not floating) a minimum time of tINACT max., after RESET is taken LOW.

3. For data signal input slew rate is  $\geq 1$ V/ns.

4. For data signal input slew rate is  $\geq 0.5$  V/ns and <1V/ns.

5. CLK,  $\overline{\text{CLK}}$  signal input slew rates are  $\geq 1$ V/ns.

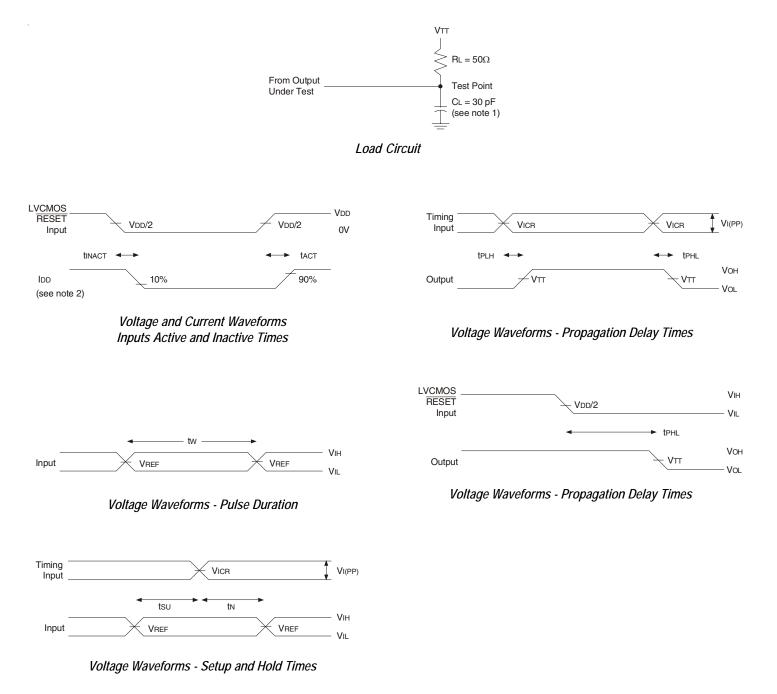
# SWITCHING CHARACTERISTICS OVER RECOMMENDED FREE-AIR OPERATING RANGE (UNLESS OTHERWISE NOTED)

		PC1600	- PC2700	PC3200		
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
<b>f</b> MAX		200	—	220	-	MHz
<b>t</b> PDM	CLK and CLK to Q	1.1	2.8	1.1	2.4(1)	ns
<b>t</b> PDMSS	CLK and CLK to Q (simultaneous switching)	—	—	-	2.7	ns
<b>T</b> PHL	RESET to Q	—	5	_	5	ns

NOTE:

1. 2.8ns for parts assembled and tested prior to WW14, 2004.

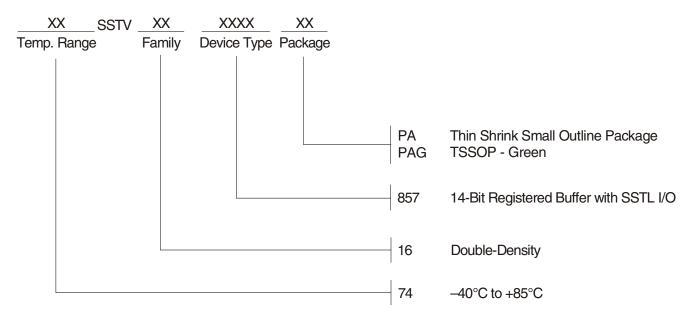
## TEST CIRCUITS AND WAVEFORMS FOR PC1600-PC2700, VDD = $2.5V \pm 0.2V$ FOR PC3200, VDD = $2.6V \pm 0.1V$



#### NOTES:

- 1. CL includes probe and jig capacitance.
- 2. IDD tested with clock and data inputs held at VDD or GND, and IO = 0mA.
- 3. All input pulses are supplied by generators having the following characteristics: PRR ≤10MHz, Zo = 50Ω, input slew rate = 1 V/ns ±20% (unless otherwise specified).
- 4. The outputs are measured one at a time with one transition per measurement.
- 5. VTT = VREF = VDDQ/2
- 6. VIH = VREF + 310mV (AC voltage levels) for differential inputs. VIH = VDD for LVCMOS input.
- 7. VIL = VREF 310mV (AC voltage levels) for differential inputs. VIL = GND for LVCMOS input.
- 8. tPLH and tPHL are the same as tPD.

#### **ORDERING INFORMATION**



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